

FYLS - 3528UYC

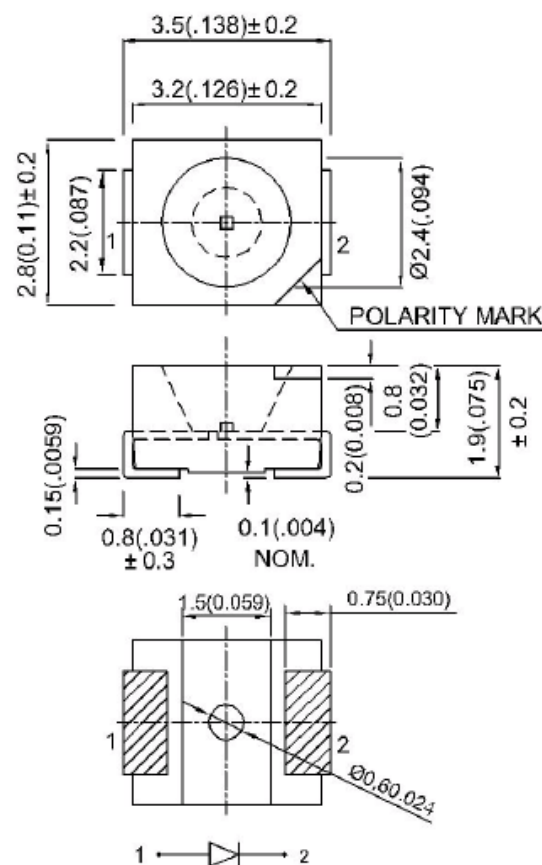
Features:

- Single color
- Suitable for all SMT assembly and solder process.
- Available on tape and Reel.
- Package : 2000 pcs / Reel

Description.

- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

1. All dimension units are millimeters (Inches)
2. All dimension tolerance $\pm 0.2\text{mm}$ unless otherwise noted.
3. An epoxy meniscus may extend about 1.5mm down the leads.

Selection Guide

Part No.	Dice	lens type	IV(mcd)@20mA		Viewing Angle
			Min	Typ	2θ _{1/2}
FYLS-3528UYC	Yellow(AlGaInP)	Water clear	400	500	120

Electrical/Optical Characteristics at Ta=25 °c

Symbol	Parameter	Device	min.	typ.	units	test conditions
λd	Dominate wavelength	Red	587	590	nm	IF=20mA
VF	Forward Voltage	Red	1.6	2.0	V	IF=20mA
IR	Reverse Current	Red		5	μA	VR=5V

Absolute Maximum Ratings At= 25 °c

Parameter	White	Units
Power dissipation	80	mW
DC Forward Current	30	mA
Peak Forward Current(1)	140	mA
Reverse Voltage	5	V
Operating/storage Temperature	-40°C to +85°C	

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

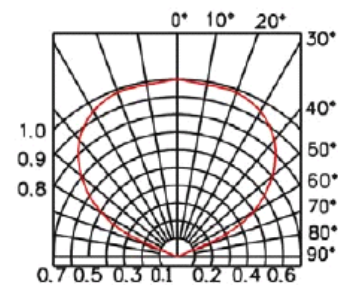
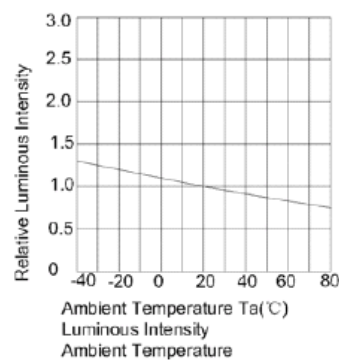
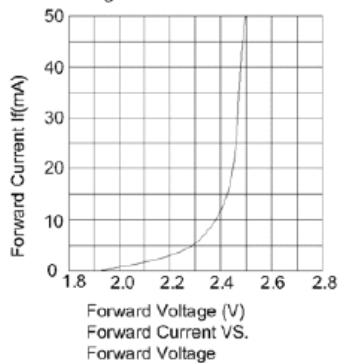
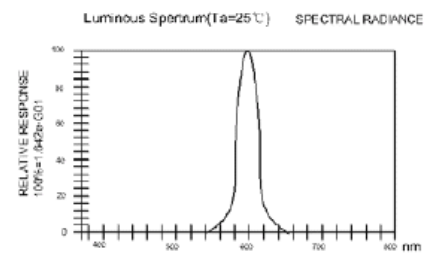
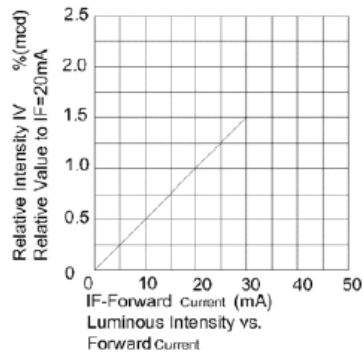
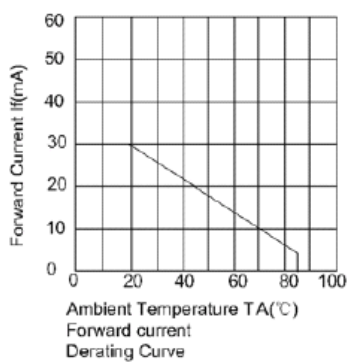
Reliability Test items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level:90% LTPD:10%

SMD

NO.	Items	test condition	test Hours/Cycles	sample Size	Ac/Rc
1	Reflow	Temp:240℃±5℃ Min:5sec	6Min	22pcs	0/1
2	Temperature cycle	H: +100℃ 15min.~5min L:-40℃~ 15min	300 Cycles	22pcs	0/1
3	Thermal shock	H: +100℃ 5min.~10sec. L:-10℃ 5min	300 Cycles	22pcs	0/1
4	High Temperature Storage	temp:100℃	1000hrs.	22pcs	0/1
5	LOW Temperature Storage	temp:-55℃	1000hrs.	22pcs	0/1
6	DC Operating Life	IF=20mA	1000hrs.	22pcs	0/1
7	High Temperature /High Humidity	85℃/R,H80%	1000hrs.	22pcs	0/1

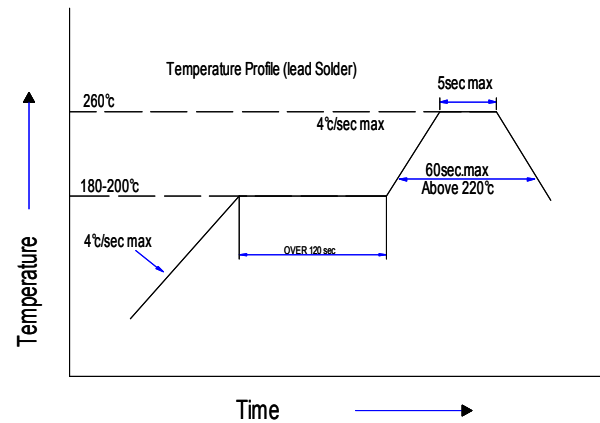
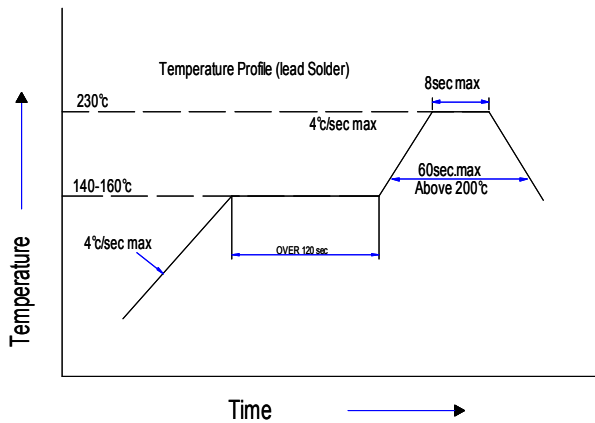


SMT Reflow Soldering Instructions

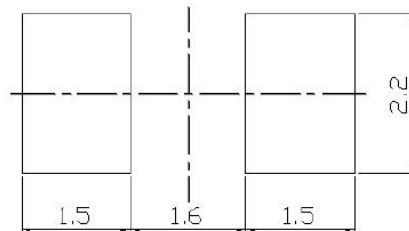
Number of reflow process shall be less than 2 times and cooling

Process to normal temperature is required between first and second soldering process

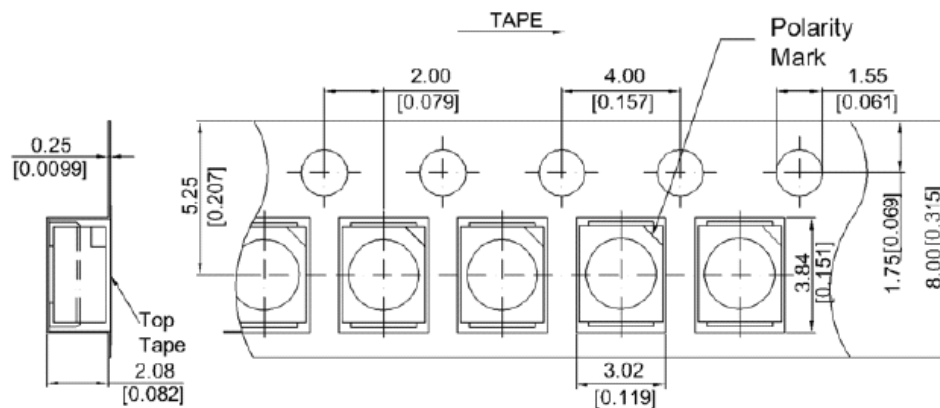
SMD



Recommended Soldering Pattern(Units:mm)

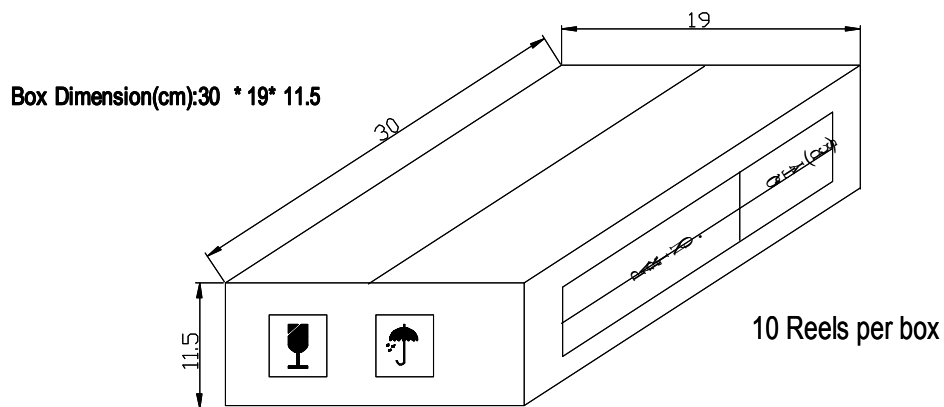
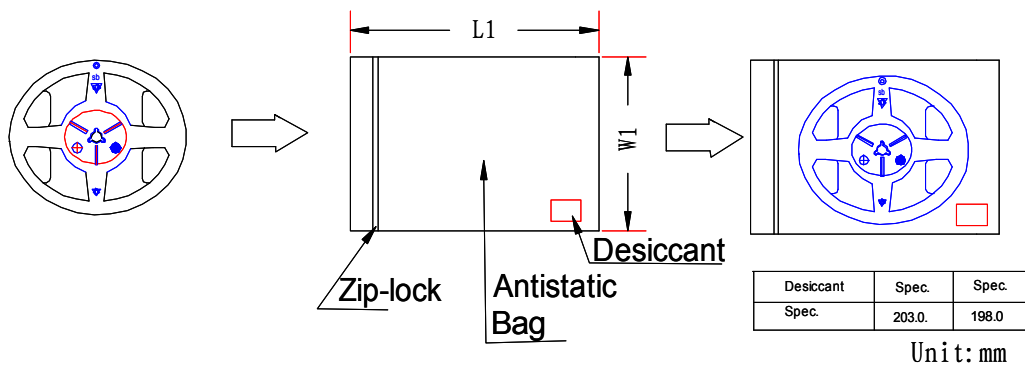


Tape Specifications (Units : mm)

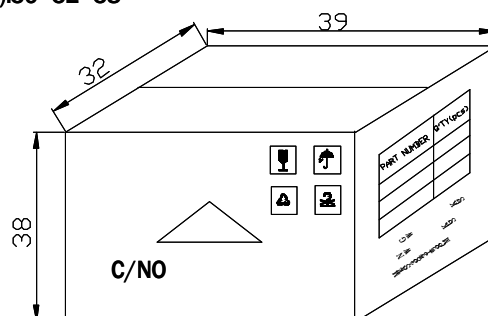


◆ Packing and Shipping Spec.

SMD



CARTON
Dimension(cm):39*32*38



6boxes/carton
0603B/0603/0805:
4000pcs*10Reels*6boxes

0805B/1206B/1206/1210/1204 :
3000pcs*10Reels*6boxes*

3528: 2000pcs*10Reels*6boxes
5050:1000pcs*8Reels*6boxes